

Product Change Notification 108983 - 00

Information in this document is provided in connection with Intel products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel products are not intended for use in medical, life saving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2008. Other names and brands may be claimed as the property of others.

Celeron, Centrino, Intel, the Intel logo, Intel Core, Intel NetBurst, Intel NetMerge, Intel NetStructure, Intel SingleDriver, Intel SpeedStep, Intel StrataFlash, Intel Viiv, Intel XScale, Itanium, MMX, Paragon, PDCharm, Pentium, and Xeon are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries.

Learn how to use Intel Trade Marks and Brands correctly at http://www.intel.com/intel/legal/tmusage2.htm.



Product Change Notification

Change Notification #: 108983 - 00

Change Title: SR2520SA, PCN 108983-00, Product Design,

Incorporate New Board Fab and Switch to Anodized Heatsink for CPU VR FET's

Date of Publication: November 07, 2008

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: Nov 24, 2008

Description of Change to the Customer:

Intel is implementing a printed circuit board (PCB) change to improve the Front Side Bus (FSB) routing for the secondary processor. This design change will result in better signal quality.

The board BMC Firmware is being updated to SPBMC64.

Intel is also changing the Processor1/Processor2 Voltage Regulator heat sink on the Intel(R) Server Board S5000VSA from a non-anodized to anodized version. This heat sink is approximately 161mm long, 10.67mm wide, and 15.5mm high and comes attached to the server board on top of the Processor1/Processor2 Voltage Regulator (VR) Field Effect Transistors (FETs). The anodized version of the heat sink is black in appearance and has improved thermal conductivity and electrical insulation characteristics. The part number for the VR Heat sink is changing from Intel part number D17794-001 to D57771-003.

Customer Impact of Change and Recommended Action:

No customer impact is being projected. However, standard system validation testing is recommended.

Products Affected / Intel Ordering Codes:

Pre Change	Pre Change	Pre Change	Pre Change	Post Change	Post Change	Post Change
Product Code	MM#	TA	PBA	MM#	TA	PBA
SR2520SAFR	892236	E10058-003	E11011-101	900456	E10058-004	E11011-200
SR2520SAXR	892249	E10060-003	E11003-102	900457	E10060-004	E11003-200
SR2520SAXSR	892251	E10062-003	E11012-101	900459	E10062-004	E11012-200
SR2520SAFRNA	893528	E10058-003	E11011-101	900476	E10058-004	E11011-200
SR2520SAXRNA	893578	E10060-003	E11003-102	900478	E10060-004	E11003-200
SR2520SAXSRNA	893537	E10062-003	E11012-101	900487	E10062-004	E11012-200

Reference Documents / Attachments:

Document: Location #:

PCN Revision History:

Date of Revision: Revision Number: Reason:

November 7, 2008 Originally Published PCN